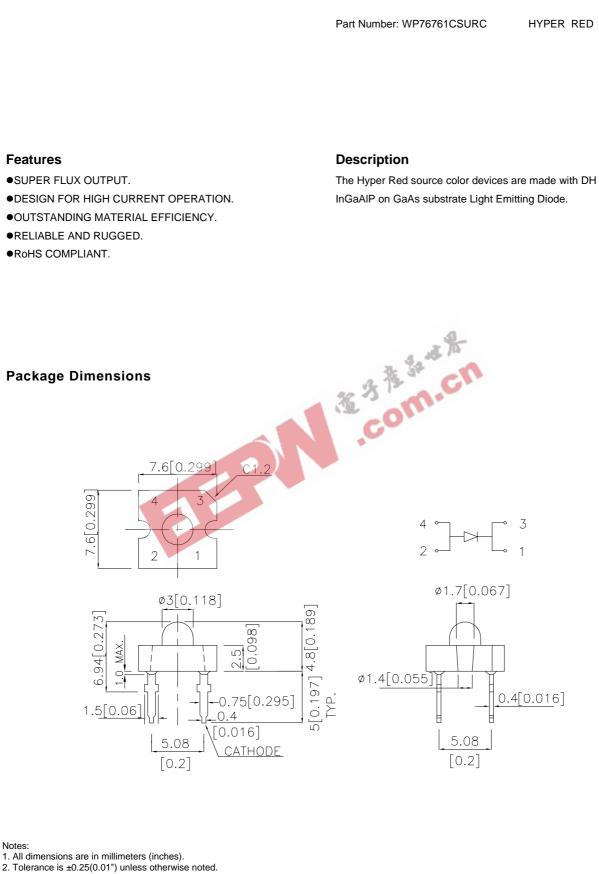
7.6mmX7.6mm SUPER FLUX LED LAMP



3. Lead spacing is measured where the leads emerge from the package.

4. Specifications are subject to change without notice.

SPEC NO: DSAG9479 **APPROVED: J. Lu**

Notes:

REV NO: V.1 CHECKED: Allen Liu DATE: NOV/04/2006 **DRAWN: S.J.LIU**

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Selection Guide lv (mcd) [2] Viewing @ 20mA *70mA Angle [1] Part No. Dice Lens Type Min. 2 0 1/2 Тур. 900 2000 WP76761CSURC HYPER RED (InGaAIP) WATER CLEAR 20° *3300 *7000

Notes:

01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
* Luminous intensity with asterisk is measured at 70mA under 40ms pulse width; Luminous intensity / luminous flux: +/-15%.

3.Drive current between 10mA and 30mA are recommended for long term performance.

4. Operation at current below 10mA is not recommended.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Min. | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|-----------|-------------------------------------|------|-----------------------------|-------|---------------------------|
| λpeak | Peak Wavelength | Hyper Red | | 640 | | nm | I _F =20mA |
| λD [1] | Dominant Wavelength | Hyper Red | | 628 | | nm | I _F =20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red | | 27 | 4 | nm | I _F =20mA |
| С | Capacitance | Hyper Red | | 45 | 4.4 | pF | V _F =0V;f=1MHz |
| Vf [2] | Forward Voltage | Hyper Red | 1.6 1.8 2.0 2.2 2.4 | S CO | 1.8 2.0 2.2 2.4 2.6 | V | I _F =20mA |
| IR | Reverse Current | Hyper Red | | | 10 | uA | $V_R = 5V$ |

2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

| Parameter | Hyper Red | Units | | |
|---|---------------------|-------|--|--|
| Power dissipation | 75 | mW | | |
| DC Forward Current | 30 | mA | | |
| Peak Forward Current [1] | 185 | mA | | |
| Reverse Voltage | 5 | V | | |
| Operating / Storage Temperature | -40°C To +85°C | | | |
| Lead Solder Temperature [2] 260°C For 3 Seconds | | | | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | | | |

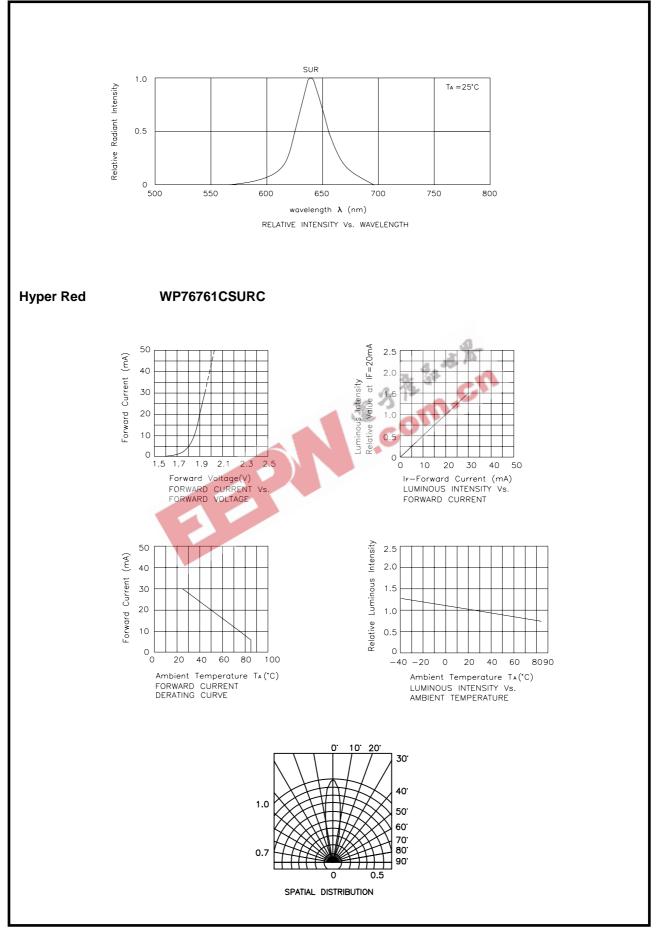
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

3. 5mm below package base.

DATE: NOV/04/2006 **DRAWN: S.J.LIU**



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